SEP 2 9 2003

Docket No.: M&N-IT-471

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below.

By:

Date: September 26, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No.

10/632,759

Inventor

Hans-Dieter Weigel

Filed

August 1, 2003

TC/A.U.

to be assigned

Examiner

to be assigned

Docket No.

M&N-IT-471

Customer No.:

24131

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. 1.98

Hon. Commissioner for Patents; Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. 1.98, copies of the following patents and/or publications are submitted herewith:

U.S. Patent No. 5,302,778 (Maurinus), dated April 12, 1994;

U.S. Patent No. 5,475,783 (Kurashima), dated December 12, 1995;

U.S. Patent No. 5,781,682 (Cohen et al.), dated July 14, 1998;

Applic. No. 10/632,759 IDS filed September 26, 2003

German Translation No. DE 694 29 700 T2 (Kurashima), dated April 5, 1995, corresponding to U.S. Patent No. 5,475,783;

German Translation No. DE 693 22 821 T2 (Maurinus et al.), dated March 2, 1994, corresponding to U.S. Patent No. 5,302,778;

International Publication No. WO 02/44796 A2 (Mertz), dated June 6, 2002;

International Publication No. WO 02/093696 A2 (Pommer et al.), dated November 21, 2002;

"Metallized Particle Interconnect – A Simple Solution for High-Speed, High-Bandwidth Applications", Tyco/Electronics, pp. 1-7;

German Office action dated August 25, 2003.

Respectfully submitted,

Mark P. Weichselbaum Reg. No. 43,248

For Applicants

Date: September 26, 2003

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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE INFORMATION DISCLOSURE STATEMENT BY APPLICANT (37 CFR 1.98(b))				Applicant Hans-Dieter Weigel				
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INITIALS	<u> </u>	PATENT NO.	DATE	PATENTEE	CLASS	CLASS	DA	<u>. L.</u>
	A	5,302,778	04/94	Maurinus				
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	С	5,781,682	07/98	Cohen et al.				
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